

1MBI400S-120

IGBT Module

1200V / 400A 1 in one-package

■ Features

- High speed switching
- Voltage drive
- Low inductance module structure

■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

■ Maximum ratings and characteristics

● Absolute maximum ratings (at Tc=25°C unless otherwise specified)

Item	Symbol	Rating	Unit	
Collector-Emitter voltage	V _{CEs}	1200	V	
Gate-Emitter voltage	V _{GES}	±20	V	
Collector current	Continuous	T _c =25°C	600	A
		T _c =80°C	400	A
	1ms	T _c =25°C	1200	A
		T _c =80°C	800	A
		-I _c	400	A
	1ms	-I _c pulse	800	A
Max. power dissipation	P _c	3100	W	
Operating temperature	T _j	+150	°C	
Storage temperature	T _{stg}	-40 to +125	°C	
Isolation voltage *1	V _{is}	AC 2500 (1min.)	V	
Screw torque	Mounting *2	3.5	N·m	
	Terminals *2	4.5	N·m	
	Terminals *2	1.7	N·m	

*1 : All terminals should be connected together when isolation test will be done

*2 : Recommendable value : Mounting 2.5 to 3.5 N·m(M5 or M6)
Terminal 3.5 to 4.5 N·m(M6), 1.3 to 1.7 N·m(M4)

● Electrical characteristics (at Tj=25°C unless otherwise specified)

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I _{CEs}	–	–	4.0	V _{GE} =0V, V _{CE} =1200V	mA
Gate-Emitter leakage current	I _{GES}	–	–	0.8	V _{CE} =0V, V _{GE} =±20V	μA
Gate-Emitter threshold voltage	V _{GE(th)}	5.5	7.2	8.5	V _{CE} =20V, I _c =400mA	V
Collector-Emitter saturation voltage	V _{CE(sat)}	–	2.3	2.6	T _c =25°C, V _{GE} =15V, I _c =400A	V
		–	2.8	–	T _c =125°C	
Input capacitance	C _{ies}	–	48000	–	V _{GE} =0V	pF
Output capacitance	C _{oes}	–	10000	–	V _{CE} =10V	
Reverse transfer capacitance	C _{res}	–	8800	–	f=1MHz	
Turn-on time	t _{on}	–	0.35	1.2	V _{CC} =600V I _c =400A V _{GE} =±15V R _g =1.8 ohm	μs
	t _r	–	0.25	0.6		
	t _{r(i)}	–	0.1	–		
Turn-off time	t _{off}	–	0.45	1.0		
	t _f	–	0.08	0.3		
Forward on voltage	V _F	–	2.7	3.5	T _j =25°C, I _F =400A, V _{GE} =0V	V
		–	2.4	–	T _j =125°C	
Reverse recovery time	t _{rr}	–	–	0.35	I _F =400A	μs

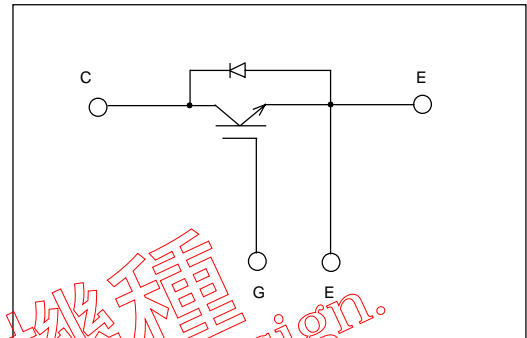
● Thermal resistance characteristics

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	R _{th(j-c)}	–	–	0.04	IGBT	°C/W
	R _{th(j-c)}	–	–	0.12	FWD	°C/W
	R _{th(c-f)*4}	–	0.0125	–	the base to cooling fin	°C/W

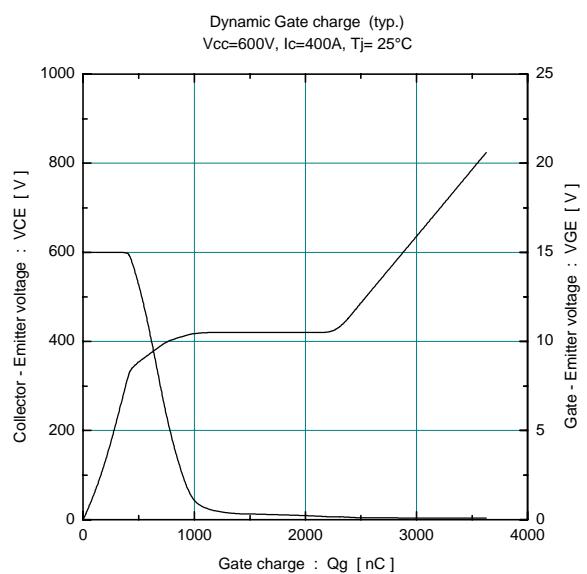
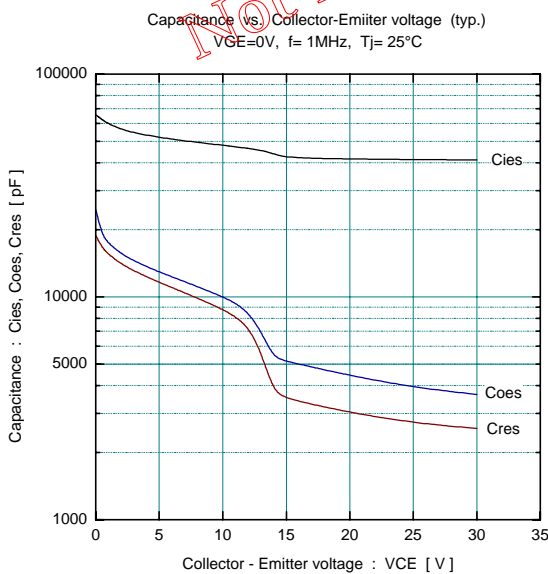
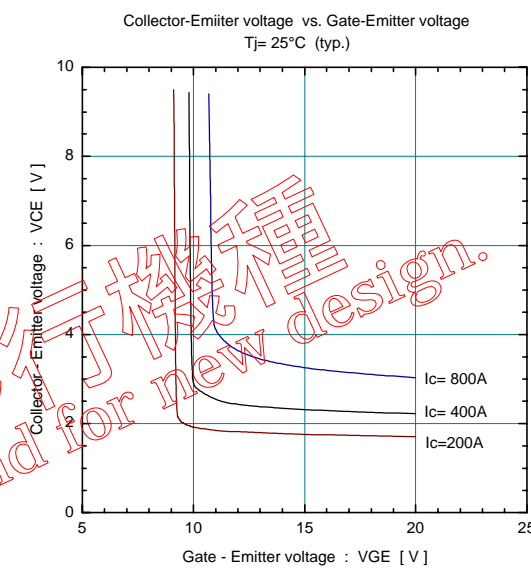
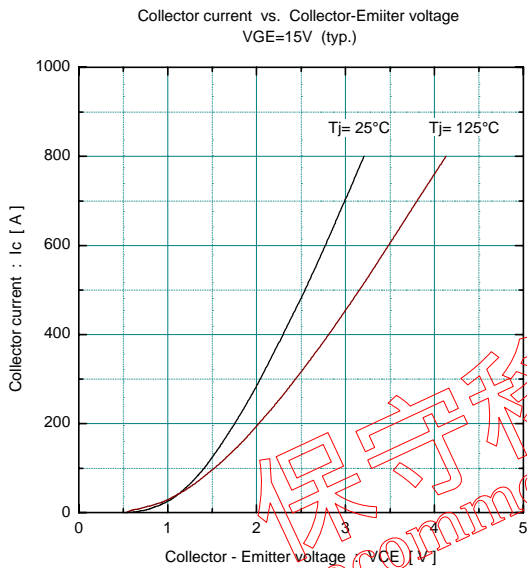
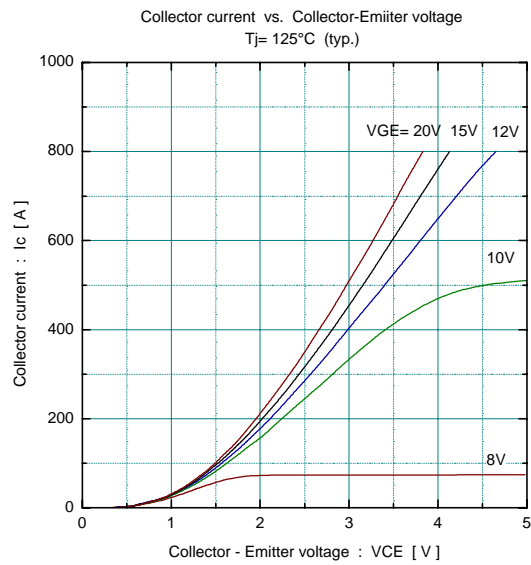
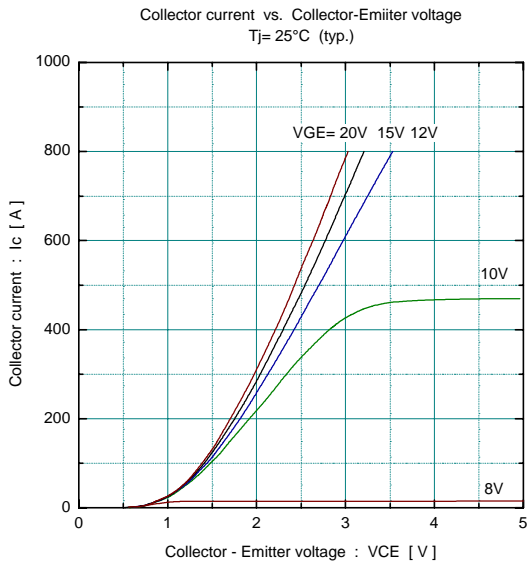
*4 : This is the value which is defined mounting on the additional cooling fin with thermal compound

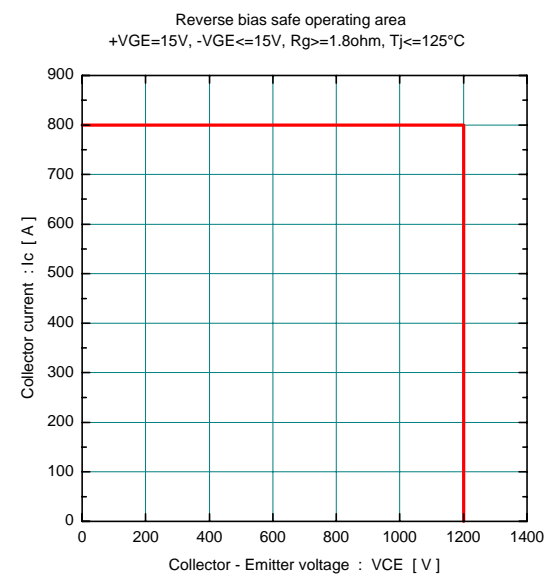
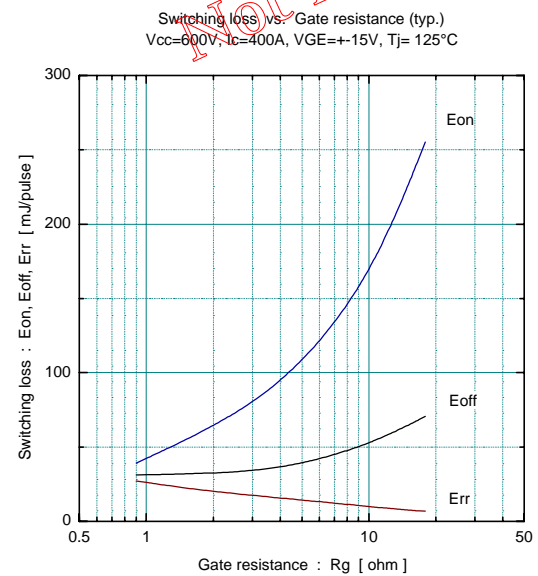
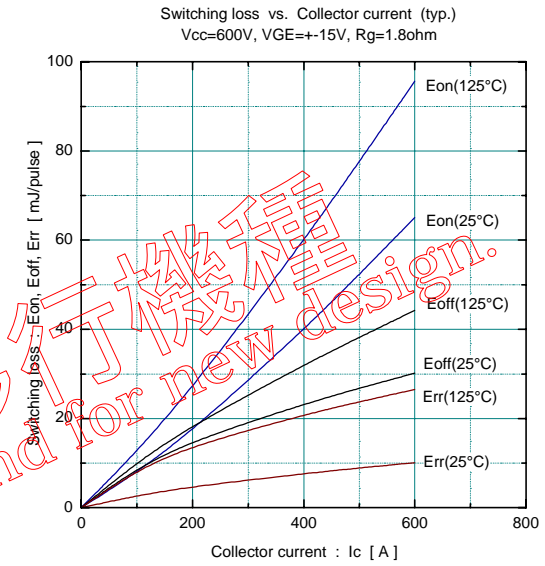
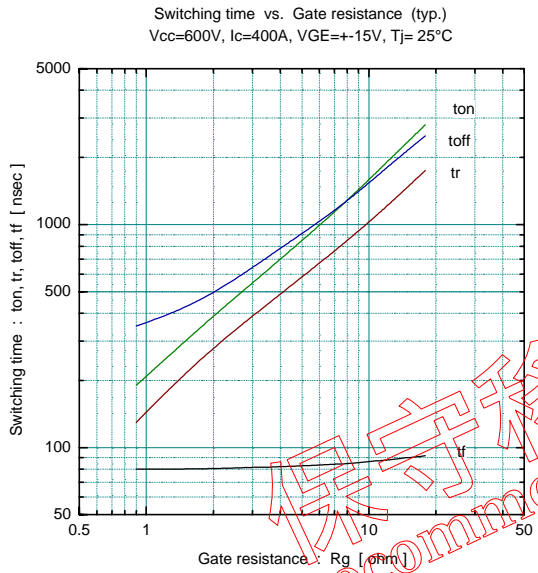
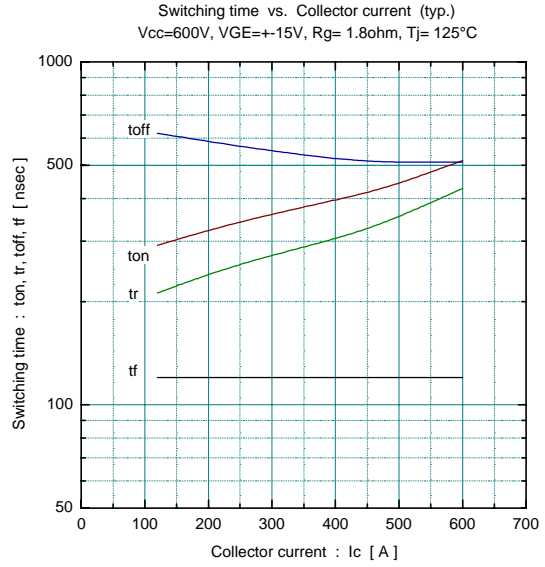
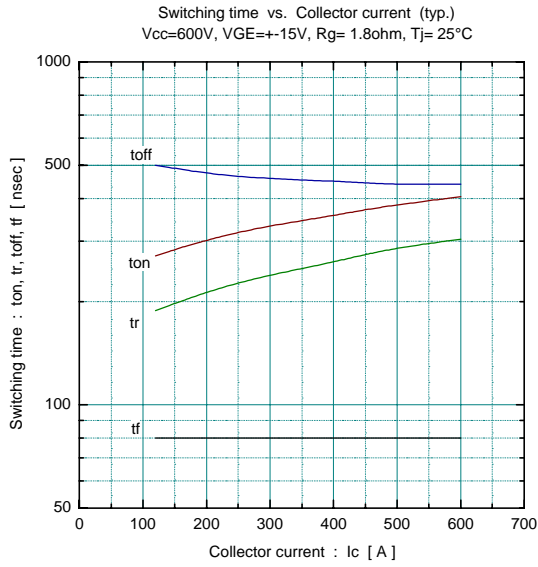


■ Equivalent Circuit Schematic



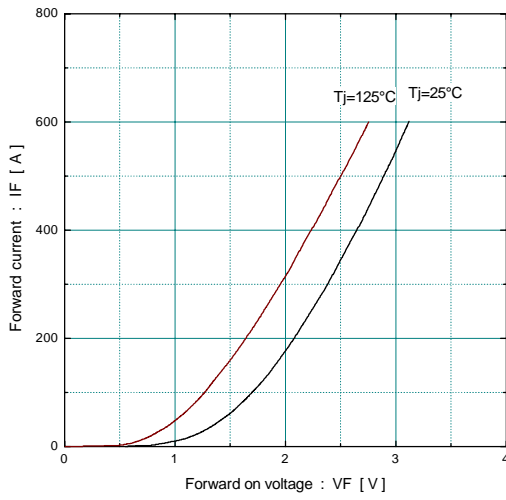
Characteristics



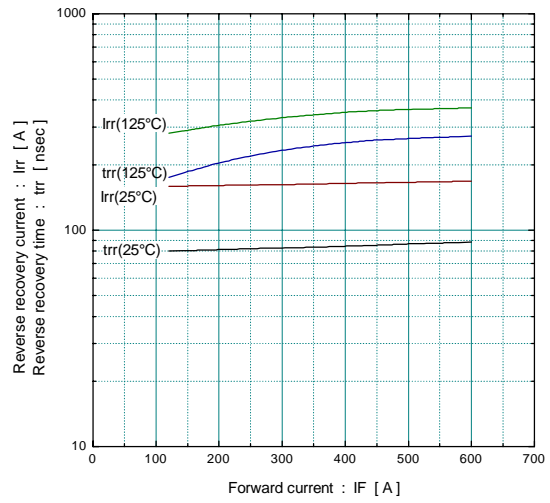


保守移行機種
 Not recommend for new design.

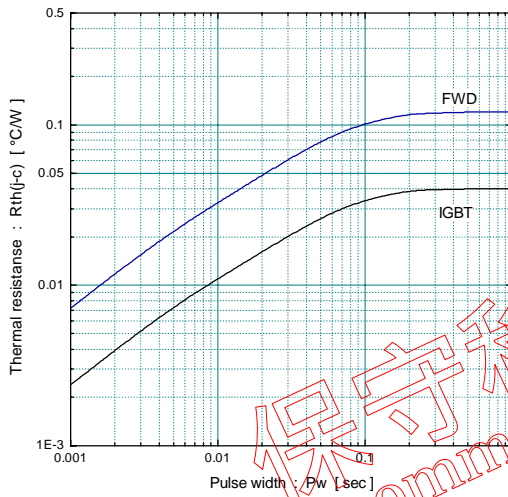
Forward current vs. Forward on voltage (typ.)



Reverse recovery characteristics (typ.)
Vcc=600V, VGE=+15V, Rg=1.8ohm

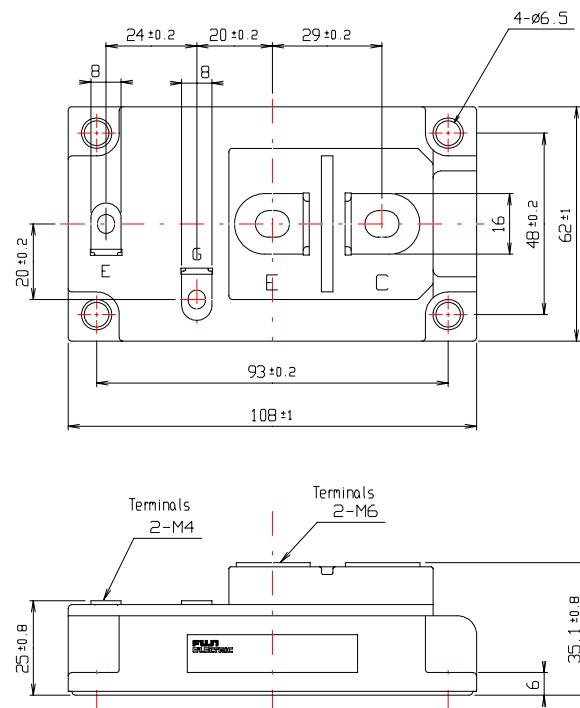


Transient thermal resistance



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■ Outline Drawings, mm



mass : 380g